

# DATA SHEET

## **BT300S series** Thyristors

Product specification

September 1997



**WeEn**

WeEn Semiconductors

# Thyristors

## BT300S series BT300M series

### GENERAL DESCRIPTION

Glass passivated thyristors in a plastic envelope, suitable for surface mounting, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

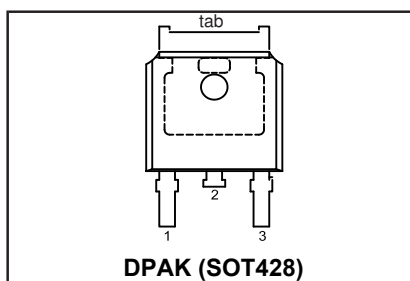
### QUICK REFERENCE DATA

| SYMBOL             | PARAMETER  | MAX.               | MAX.               | MAX.               | UNIT |
|--------------------|--|--------------------|--------------------|--------------------|------|
| $V_{DRM}, V_{RRM}$ | <b>BT300S (or BT300M)-</b><br>Repetitive peak off-state voltages | <b>500R</b><br>500 | <b>600R</b><br>600 | <b>800R</b><br>800 | V    |
| $I_{T(AV)}$        | Average on-state current   | 5                  | 5                  | 5                  | A    |
| $I_{T(RMS)}$       | RMS on-state current   | 8                  | 8                  | 8                  | A    |
| $I_{TSM}$          | Non-repetitive peak on-state current                             | 65                 | 65                 | 65                 | A    |

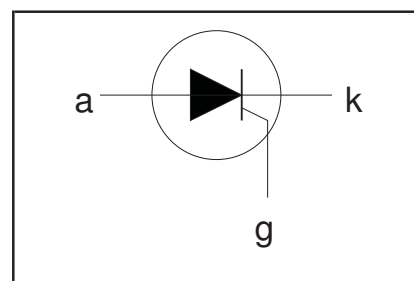
### PINNING - SOT428

| PIN NUMBER | Standard S | Alternative M |
|------------|------------|---------------|
| 1          | cathode    | gate          |
| 2          | anode      | anode         |
| 3          | gate       | cathode       |
| tab        | anode      | anode         |

### PIN CONFIGURATION



### SYMBOL



### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL             | PARAMETER  | CONDITIONS  | MIN. | MAX.                             |                                  |                     | UNIT              |
|--------------------|--|---|------|----------------------------------|----------------------------------|---------------------|-------------------|
| $V_{DRM}, V_{RRM}$ | Repetitive peak off-state voltages                           |   | -    | <b>-500R</b><br>500 <sup>1</sup> | <b>-600R</b><br>600 <sup>1</sup> | <b>-800R</b><br>800 | V                 |
| $I_{T(AV)}$        | Average on-state current                                     | half sine wave; $T_{mb} \leq 107^\circ\text{C}$                             | -    | 5                                |                                  |                     | A                 |
| $I_{T(RMS)}$       | RMS on-state current   | all conduction angles   | -    | 8                                |                                  |                     | A                 |
| $I_{TSM}$          | Non-repetitive peak on-state current                         | half sine wave; $T_j = 25^\circ\text{C}$ prior to surge                     | -    | 65                               |                                  |                     | A                 |
|                    |  | $t = 10\text{ ms}$  | -    | 71                               |                                  |                     | A                 |
|                    |  | $t = 8.3\text{ ms}$   | -    | 21                               |                                  |                     | A <sup>2</sup> s  |
| $I^2t$             | $I^2t$ for fusing  | $t = 10\text{ ms}$  | -    | 50                               |                                  |                     | A <sup>2</sup> μs |
| $di_T/dt$          | Repetitive rate of rise of on-state current after triggering | $I_M = 10\text{ A}; I_G = 50\text{ mA}; di_G/dt = 50\text{ mA}/\mu\text{s}$ | -    | 50                               |                                  |                     | A/μs              |
| $I_{GM}$           | Peak gate current  |   | -    | 2                                |                                  |                     | A                 |
| $V_{GM}$           | Peak gate voltage  |   | -    | 5                                |                                  |                     | V                 |
| $V_{RGM}$          | Peak reverse gate voltage                                    |   | -    | 5                                |                                  |                     | V                 |
| $P_{GM}$           | Peak gate power  |   | -    | 5                                |                                  |                     | W                 |
| $P_{G(AV)}$        | Average gate power   | over any 20 ms period   | -    | 0.5                              |                                  |                     | W                 |
| $T_{stg}$          | Storage temperature  |   | -40  | 150                              |                                  |                     | °C                |
| $T_j$              | Operating junction temperature                               |   | -    | 125                              |                                  |                     | °C                |

<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

## Thyristors

BT300S series  
BT300M series**THERMAL RESISTANCES**

| SYMBOL         | PARAMETER                                    | CONDITIONS                                | MIN. | TYP. | MAX. | UNIT |
|----------------|--|---|------|------|------|------|
| $R_{th\ j-mb}$ | Thermal resistance junction to mounting base | pcb (FR4) mounted; footprint as in Fig.14 | -    | -    | 2.2  | K/W  |
| $R_{th\ j-a}$  | Thermal resistance junction to ambient       |   | -    | 75   | -    | K/W  |

**STATIC CHARACTERISTICS** $T_j = 25\text{ °C}$  unless otherwise stated

| SYMBOL     | PARAMETER                 | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|------------|---------------------------|--|------|------|------|------|
| $I_{GT}$   | Gate trigger current      | $V_D = 12\text{ V}; I_T = 0.1\text{ A}$  | -    | 2    | 15   | mA   |
| $I_L$      | Latching current          | $V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$   | -    | 10   | 40   | mA   |
| $I_H$      | Holding current           | $V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$   | -    | 10   | 20   | mA   |
| $V_T$      | On-state voltage          | $I_T = 12\text{ A}$  | -    | 1.35 | 1.6  | V    |
| $V_{GT}$   | Gate trigger voltage      | $V_D = 12\text{ V}; I_T = 0.1\text{ A}$  | -    | 0.6  | 1.5  | V    |
| $I_D, I_R$ | Off-state leakage current | $V_D = V_{DRM(max)}; I_T = 0.1\text{ A}; T_j = 125\text{ °C}$<br>$V_D = V_{DRM(max)}; V_R = V_{RRM(max)}; T_j = 125\text{ °C}$ | 0.25 | 0.4  | -    | V    |
|            |                           |  | -    | 0.1  | 0.5  | mA   |

**DYNAMIC CHARACTERISTICS** $T_j = 25\text{ °C}$  unless otherwise stated

| SYMBOL    | PARAMETER                                  | CONDITIONS   | MIN. | TYP. | MAX. | UNIT       |
|-----------|--|--|------|------|------|------------|
| $dV_D/dt$ | Critical rate of rise of off-state voltage | $V_{DM} = 67\% V_{DRM(max)}; T_j = 125\text{ °C};$<br>exponential waveform.  |      |      |      |            |
|           |  | Gate open circuit<br>$R_{GK} = 100\ \Omega$  | 50   | 100  | -    | V/ $\mu$ s |
| $t_{gt}$  | Gate controlled turn-on time               | $I_{TM} = 10\text{ A}; V_D = V_{DRM(max)}; I_G = 0.1\text{ A};$<br>$dI_G/dt = 5\text{ A}/\mu\text{s}$  | 200  | 1000 | -    | V/ $\mu$ s |
| $t_q$     | Circuit commutated turn-off time           | $V_D = 67\% V_{DRM(max)}; T_j = 125\text{ °C};$<br>$I_{TM} = 12\text{ A}; V_R = 25\text{ V}; dI_{TM}/dt = 30\text{ A}/\mu\text{s};$<br>$dV_D/dt = 50\text{ V}/\mu\text{s}; R_{GK} = 100\ \Omega$ | -    | 70   | -    | $\mu$ s    |

Thyristors

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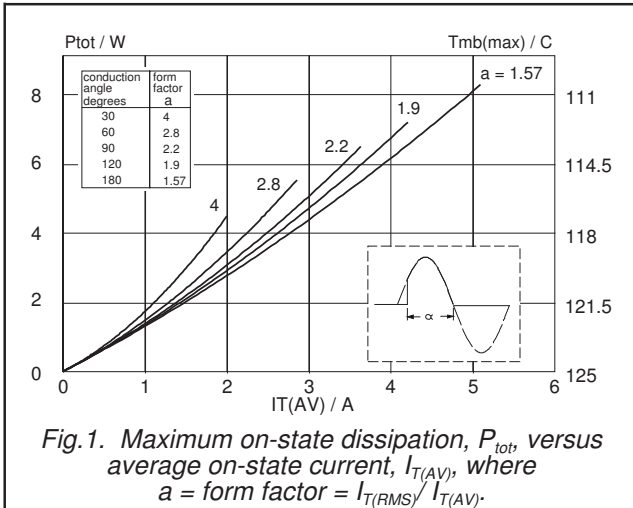


Fig. 1. Maximum on-state dissipation,  $P_{tot}$ , versus average on-state current,  $I_{T(AV)}$ , where  $a = \text{form factor} = I_{T(RMS)} / I_{T(AV)}$ .

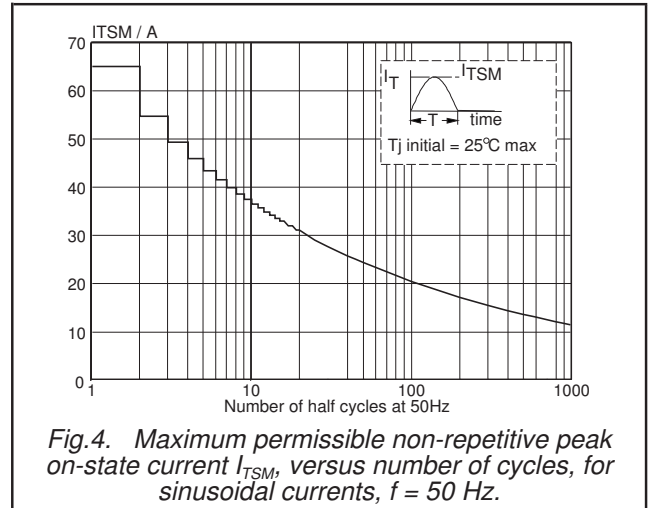


Fig. 4. Maximum permissible non-repetitive peak on-state current  $I_{TSM}$ , versus number of cycles, for sinusoidal currents,  $f = 50 \text{ Hz}$ .

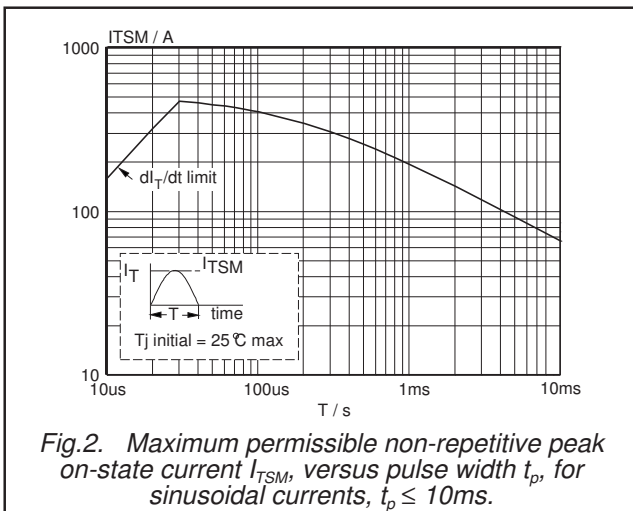


Fig. 2. Maximum permissible non-repetitive peak on-state current  $I_{TSM}$ , versus pulse width  $t_p$ , for sinusoidal currents,  $t_p \leq 10 \text{ ms}$ .

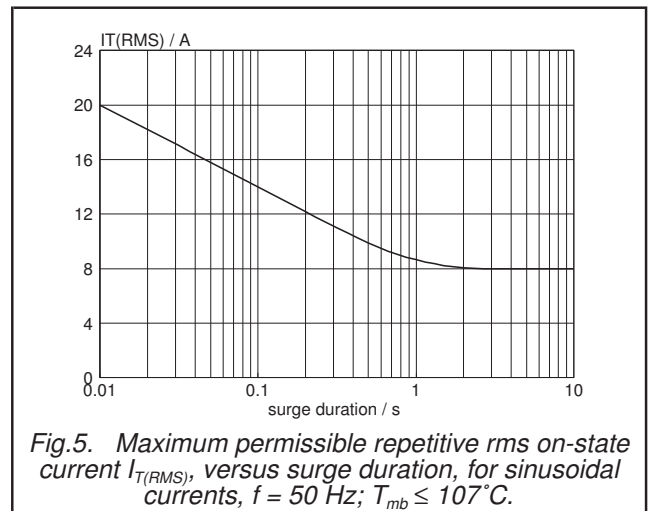


Fig. 5. Maximum permissible repetitive rms on-state current  $I_{T(RMS)}$ , versus surge duration, for sinusoidal currents,  $f = 50 \text{ Hz}$ ;  $T_{mb} \leq 107^\circ\text{C}$ .

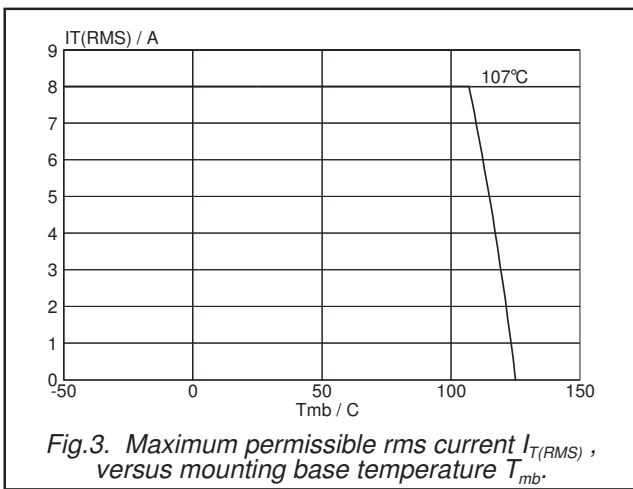


Fig. 3. Maximum permissible rms current  $I_{T(RMS)}$ , versus mounting base temperature  $T_{mb}$ .

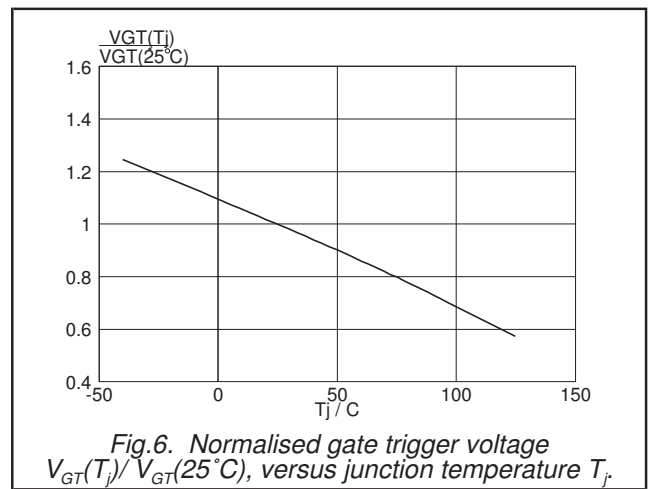
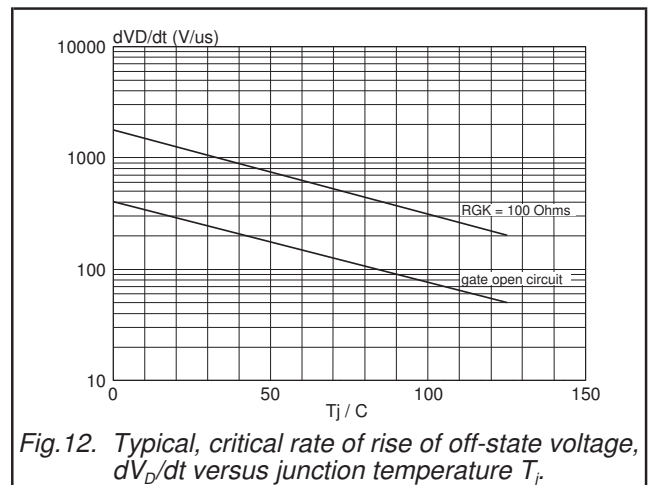
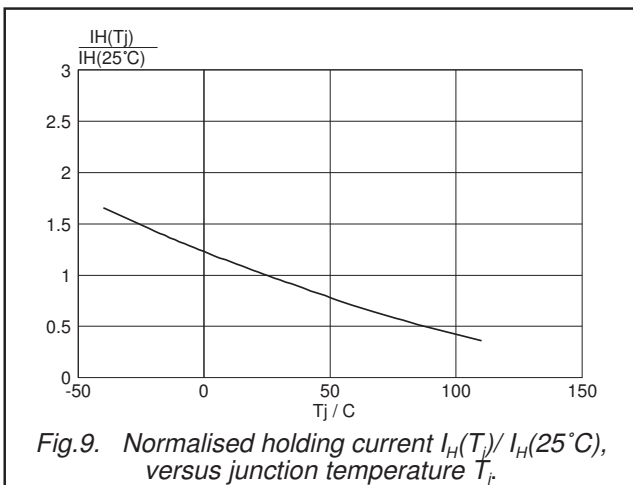
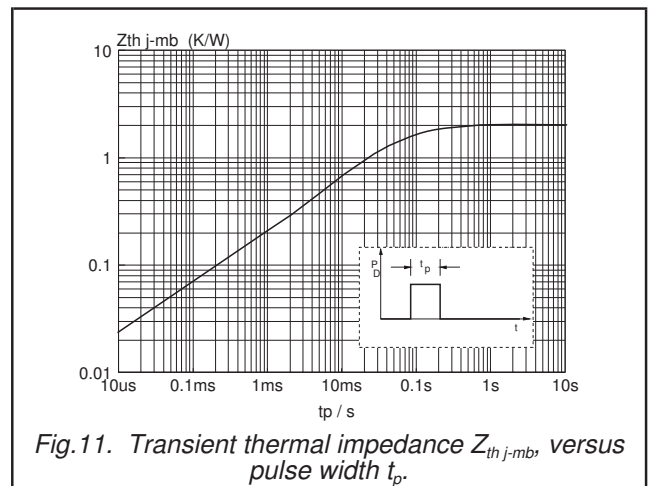
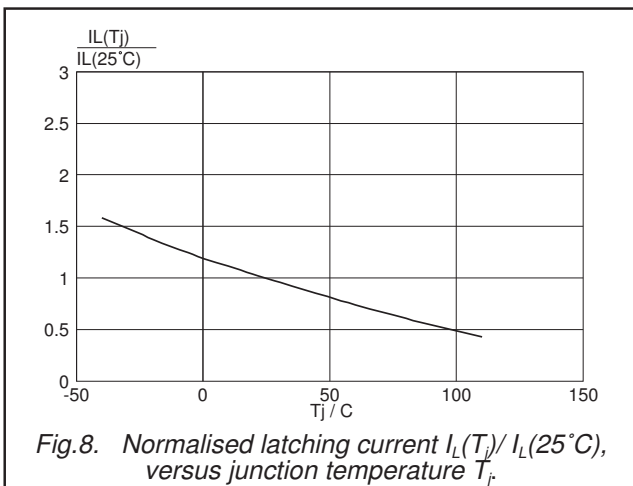
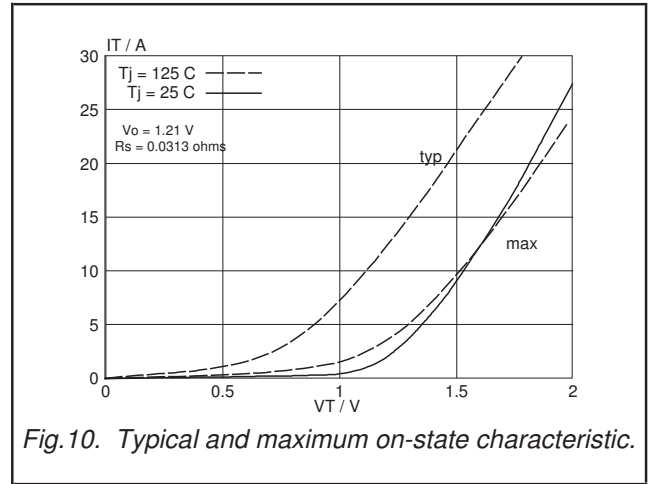
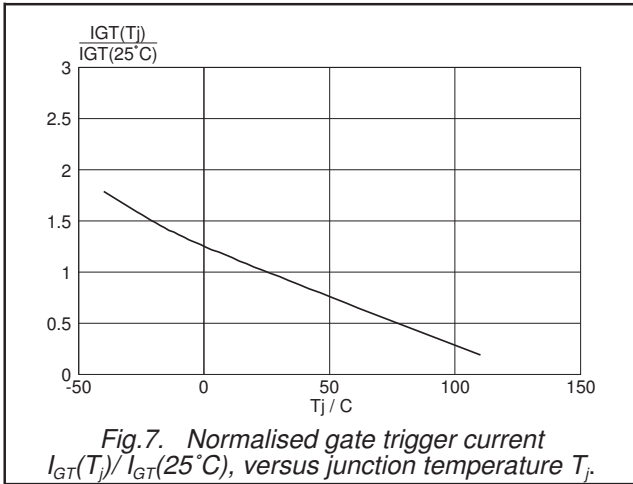


Fig. 6. Normalised gate trigger voltage  $V_{GT}(T_j) / V_{GT}(25^\circ\text{C})$ , versus junction temperature  $T_j$ .

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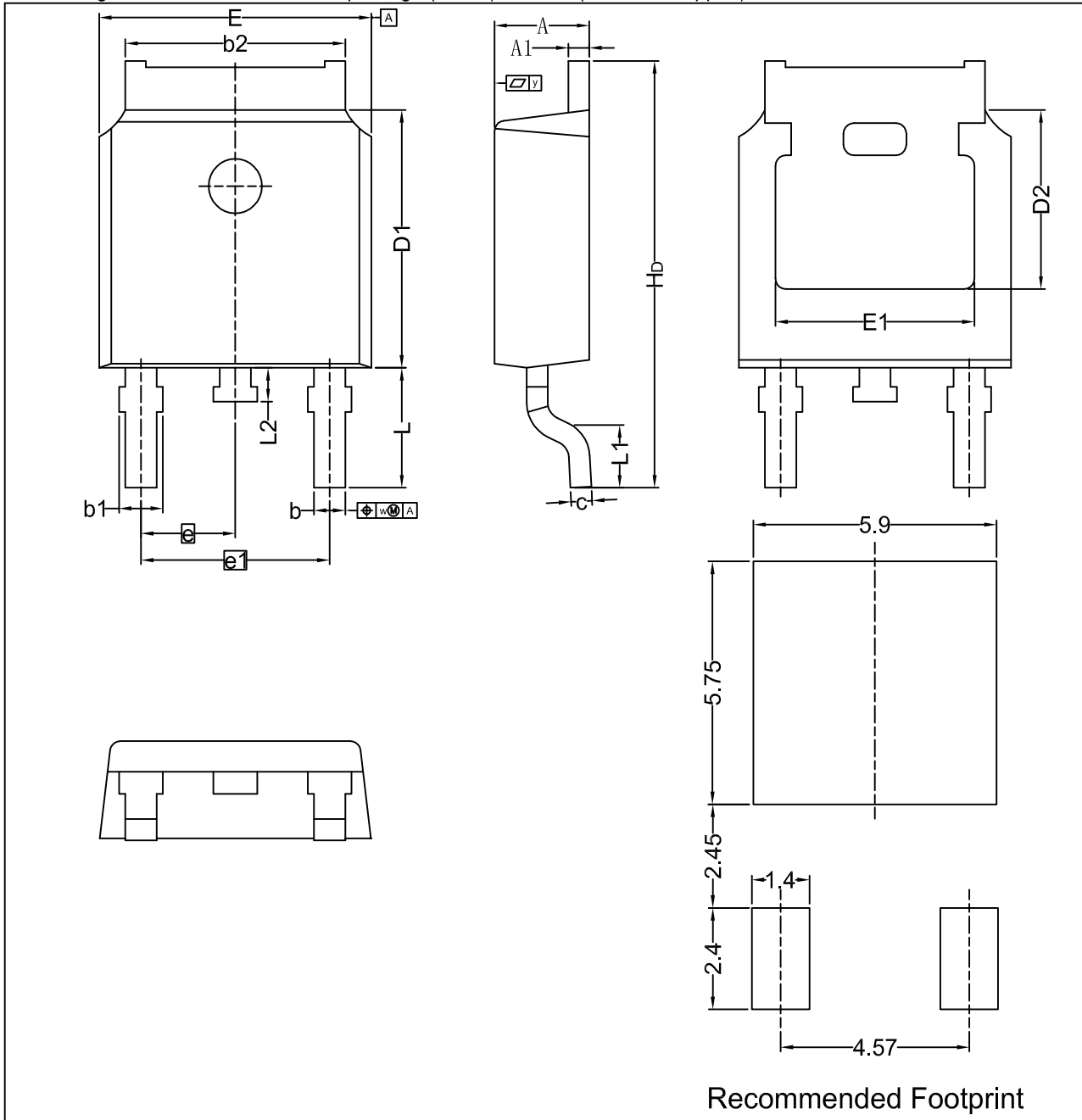
Thyristors

BT300S series  
BT300M series

**MECHANICAL DATA**

Plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)

TO252



Recommended Footprint

| Unit   | A    | A1   | b    | b1   | b2   | c    | D1   | D2   | E    | E1   | e     | e1   | H <sub>D</sub> | L              | L1   | L2   | w    | y    |
|--------|------|------|------|------|------|------|------|------|------|------|-------|------|----------------|----------------|------|------|------|------|
| min    | 2.22 | 0.46 | 0.71 | 0.72 | 5.00 | 0.20 | 5.98 | 4.00 | 6.47 | 4.45 | 2.285 | 4.57 | 9.60           | 2.90<br>(Ref.) | 0.50 | 0.50 | 0.20 |      |
| mm nom |      |      |      |      |      |      |      |      |      |      |       |      |                |                |      |      |      |      |
| max    | 2.38 | 0.93 | 0.89 | 1.10 | 5.46 | 0.56 | 6.22 | ---  | 6.73 | ---  |       |      | 10.40          |                | ---  | 0.90 |      | 0.20 |

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